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DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

"MOUNTING STRUCTURE OF A SEMICONDUCTOR DEVICE, AND A PROCESS FOR MOUNTING A SEMICONDUCTOR DEVICE ON A MOUNTING SUBSTRATE"

Case No	, <u>09792909-0326</u> , the	specification of which								
	(check X one)	is attached hereto was filed on May 1, 2000 Application Serial No. 09/561,94 and was amended on (if applica	able)							
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims as amended by any amendment referred to above.										
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent Office all information which is known to more to be material to the patentability of this application in accordance with Title 37, Code of Federal Regulations. 1.5 I do not know and do not believe this invention was ever known or used in the United States of America before my or our invention thereof, or patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to this application, that the same was not in public use or on sale to United States of America more than one year prior to this application, and I believe that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months prior to this application, and that no application for patent or inventor's certificate on this invention has been filed in any country foreign to the United States of America prior to this application by me or make the united States of America prior to this application by me or make the united States of America prior to this application by me or make the united States of America prior to this application by me or make the united States of America prior to this application by me or make the united States of America prior to this application by me or make the united States of America prior to this application by me or make the united States of America prior to this application by me or make the united States of America prior to this application by me or make the united States of America prior to this application by me or make the united States of America prior to this application by me or make the united States of America prior										
							Number	Country	Date	
							JP11-132104	Japan	May 13, 1999	

and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the above listed application on which priority is claims:

¹ (b) Under this section, information is material to patentability when it is not cumulative to information already of record or being made of record in the application, and

⁽¹⁾ It establishes, by itself or in combination with other information, a primafacie case of unpatentability of a claim; or

⁽²⁾ It refutes, or is inconsistent with, a position the application takes in:

⁽i) opposing an argument of unpatentability relied on by the Office, or

⁽ii) asserting an argument of patentability.

A prima facie case of unpatentability is established when the information compels a conclusion that a claim is unpatentable under the preponderance of evidence, burden of proof standard, giving each term in the claim its broadest reasonable construction consistent with the specification, and before any consideration is given to evidence which may be submitted in an attempt to establish a contrary conclusion of patentability.

Prior Foreign Application(s)					
Number	Country	Date			
If no priority is claimed, I Prior Foreign Application(have identified all foreign patent ap	plications filed prior to this a	pplication:		
Number	Country	Date			

And I hereby appoint Joseph A. Mahoney (Reg. No. 38,956), Howard B. Rockman (Reg. No. 22,190), Jordan A. Sigale, (Reg. No. 39,028), Michael A. Molano (Reg. No. 39,777), Michael L. Kiklis (Reg. No. 38,939), Janelle D. Strode (Reg. No. 34,738), Kevin W. Guynn (Reg. No. 29,972), David R. Metzger (Reg. No. 32,919), Jennifer Hammond (Reg. No. 41,814), Lana Knedlik (Reg. No. 42,748), John F. Griffith (Reg. No. 44,137), Marina Saito (Reg. No. 42,121), Alison P. Schwartz (Reg. No. 43,863), Christopher P. Rauch (Reg. No. 45,034), Francisco Rubio-Campos (Reg. No. 45,358), Brian J. Gill (Reg. No. 46,727) and Shashank S. Upadbye, all members of the firm of Sonnenschein, Nath & Rosenthal

Telephone 312/876-0200 Ext. 2578

my attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith and direct that all correspondence be forwarded to:

SONNENSCHEIN NATH & ROSENTHAL 80th Floor – Sears Tower 233 S. Wacker Drive, Chicago, IL 60606

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. Full name of sole or first inventor October 24, 2000 Date Inventor's signature Residence Citizenship Japan c/o Sony Corporation, 7-35, Kitashinagawa 6-chome Post Office Address Shinagawa-ku, Tokyo 141, Japan Full name of second inventor Date Grownber Inventor's signature Aiichi, Japan Residence Citizenship Japan Post Office Address c/o Sony Corporation, 7-35, Kitashinagawa 6-chome Shinagawa-ku, Tokyo 141, Japan Full name of third inventor Date Movember 7, 2000 Inventor's signature Residence Aiichi, Japan Citizenship Post Office Address c/o Sony Corporation, 7-35, Kitashinagawa 6-chome

Shinagawa-ku, Tokyo 141, Japan

Full name of fourth inventor	MASAWII ISUKUWII		
Inventor's signature	Masami Teurumi	Date	november, 15. 700
Residence	Aiichi, Japan		
Citizenship	Japan		
Post Office Address	wa 6-chome		
Shinagawa-ku, Tokyo 141, Japan			

ASSIGNMENT

ASSIGNMENT
WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in MOUNTING STRUCTURE OF A SEMICONDUCTOR DEVICE, AND A PROCESS FOR MOUNTING A SEMICONDUCTOR DEVICE ON A MOUNTING SUBSTRATE for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;
AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;
And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;
And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;
And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.
And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/561,941 Filing Date: May 1, 2000
This assignment executed on the dates indicated below.
DAI SASAKI
Name of first or sole inventor Execution date of U.S. Patent Application
TOKYO, JAPAN
Residence of first or sole inventor Dai Sasaki October 24, 2000
Signature of first or sole inventor Date of this assignment

TOHRU TERASAKI	
Name of second inventor	Execution date of U.S. Patent Application
AICHI, JAPAN	- Service of the serv
Residence of second inventor	
- Tolo 100 - 70000 60	Provember. 7, 2000 Date of this assignment
John Ferasaki Signature of second inventor	November. 1. 2000
	Date of this assignment
MASUO KATO	
Name of third inventor	Execution date of U.S. Patent Application
AICHI, JAPAN	
Residence of third inventor	
Masuro Kato	Movember 7. 2000
Signature of third inventor	Date of this assignment
O O O MASAMI TSURUMI	
्राच्या स्थापन स्थापन	
Li Magnet Forest	
MASAMI TSURUMI Name of fourth inventor	
# SOLIORITH HINGHTON	Execution date of U.S. Patent Application
AICHI, JAPAN	
Residence of fourth inventor	0 4
Masami Isurumi	November. 15. 2000
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	

Date of this assignment

Signature of fifth inventor